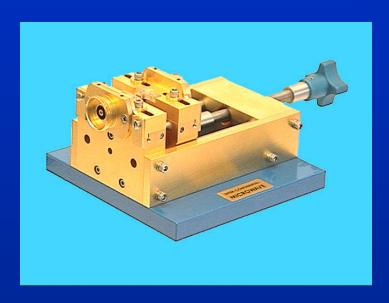


The World-Wide Authority in the Design & Manufacture of Microwave Test Fixtures



Adjustable Mainframe
Test Fixture

### • Test Fixture Mainframe

- Up to DC -40 GHz
- Connector Options:
  - APC-7, APC-3.5, Super-SMA, K, 2.4 mm
- Interchangeable Transitions
- RF-in / RF-out offset adjustable
- Extended length option
- Full Temp. available (-55 to +125 °C)
- Ratchet closing mechanism (option)
- In field spare parts kit
- In-fixture TRL Calibration Standards

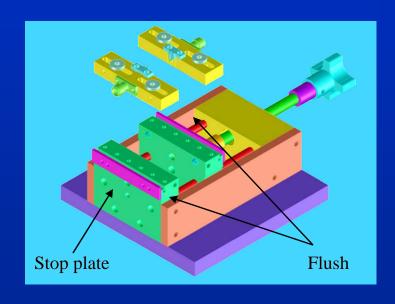
## Transitionsfor AdjustableMainframes



#### • Transition Assemblies

- Allows conversion of mainframe to any connector type
- Available Connectors: APC-7,
   APC-3.5, Super-SMA, K, 2.4 mm
- Male or female connectors available
- Conversion to Full Temp. with Super-SMA Connectors
- Dual RF launch also available for special insert assemblies
- Both RF-Launch positions adjustable in x,y and z-axis

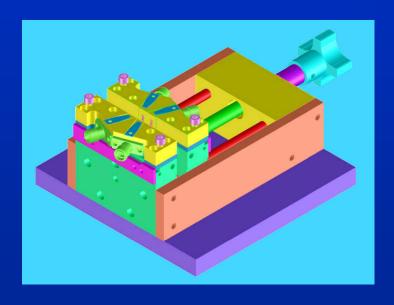
# Howto ChangeTransitions



#### • Mainframe Transition Assemblies

- Mounted with 2 screws on each side
- Stop plate for parallel alignment
- Slot for offset mounting
- Mount transition ends flush for RF-Pin centering
- Use shim (not shown) under transition for adjustment in z-axis
- Use spare transition assemblies for level 1 in-field service

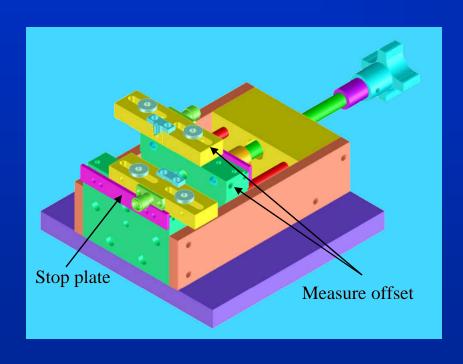
# MultipleRF Inputs



#### • Custom Transitions

- Mount onto basic mainframe
- Up to 4 RF inputs per mainframe
- Different RF to RF pin spacing can be specified
- DC 40 GHz designs available
- Custom Calibration Kits upon request
- Contact Factory with your requirements

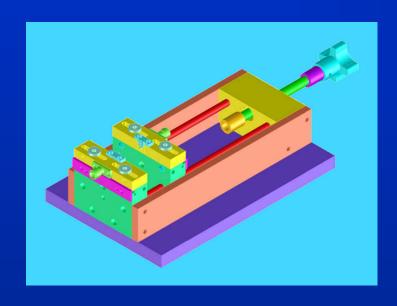
## OffsettingInput andOutput



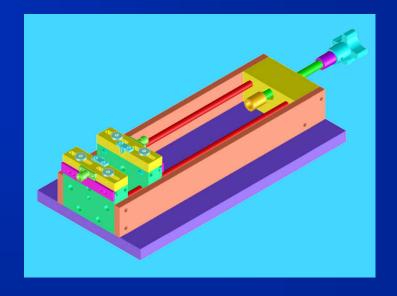
#### • Transitions offset

- 0 to 600 mils left or right offset of RF-pins
- Measure offset from the edges
- Before fastening push the transition up against the stop plate
- TRL or TOSL Calibration can be performed with the RF-pins centered and then adjust the offset

# <u>StretchedMainframes</u>

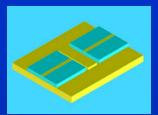


Extended length (+2"), TF-3002-x

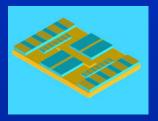


Extended length (+4"), TF-3003

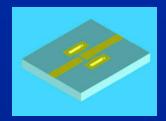
# Universaluse of Mainframe



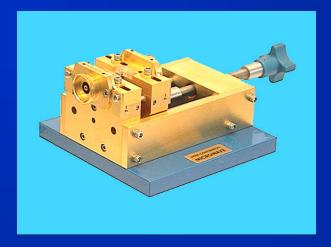
FET Chip Testing



MMIC Chip Testing



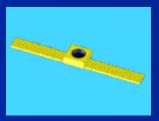
**Bipolar Chip Testing** 



**Adjustable Mainframe** 



Calibration Standards



Diode Testing



**Transistor Testing** 



SOT & SOD Testing

## Mainframewith Midsection





### • Midsection Adapters

- Turning the knob counterclockwise opens the mainframe
- The Midsection Adapter is placed between the Transitions
- Turning the knob clockwise will close the mainframe
- The Midsection Adapter will be automatically aligned and lifted up under the RF-pins when the Mainframe is closed
- The Mainframe should be closed real tight for perfect grounding

### **LowPower Transistors**

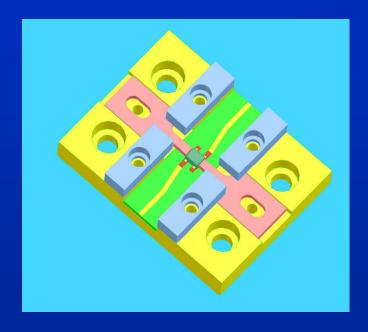






- Packaged Transistor Measurements
  - Ideal for S-parameter, Noise Figure and Power measurements
  - 10, 15, and 25 mil substrates available
  - De-embedding with TRL/LRM
     Calibration Standards
  - Measurement Environment Equal to Application Environment
  - Midsections for over 1000 different packages
  - Full Temp. (-55 to +125  $^{\circ}$  C) as option
  - Custom Midsections available

# <u>InsertAssembly</u>



**Insert Assembly for Midsection** 

- Insert Assemblies for Midsection Adapters
  - Insert Assemblies are custom designed to match the DUT
  - The length of the microstrip at the RF input and output is standardized to 330 mils
  - Adjustable Dielectric Guides align the DUT with the RF lines
  - DURA contacts provide long life in the contact areas
  - Different pin connections require different insert assemblies

# <u>MidsectionAdapter</u>



Midsection Adapter with insert

- Midsection Adapter
  - Consists of:
    - Insert Assembly and Midsection Assembly
    - Midsection and Insert have to have the same width
    - Midsection cover assembly is matched to insert and DUT
    - For some devices multiple inserts can fit the same midsection (different pin connections to DUT)

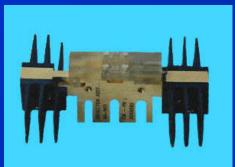
# Midsectionswith Cooling



With liquid cooling



With air and liquid cooling



With air cooling



TRL and TOSL Calibration Kits

#### **Medium Power Transistor**

- Ideal for S-parameter, Noise Figure and Power measurements
- -Fit into all mainframes

10, 15, and 25 mil substrates available

De-embedding with TRL Calibration Standards

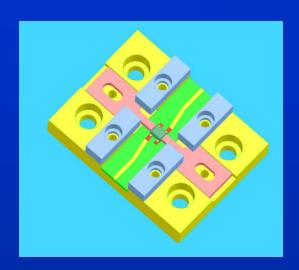
Measurement Environment Equal to Application Environment

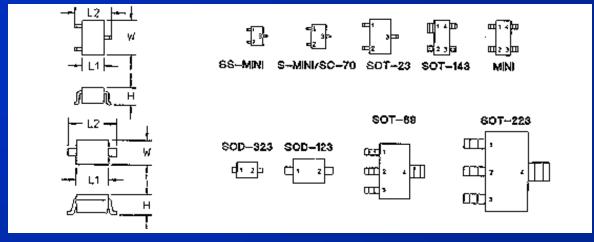
With Air fin or liquid cooling

Full Temp. available (-55 to +125° C)

Custom Midsections available

### ModernSurface MountTransistors







#### • Surface Mount Transistors

- Midsection Adapters for all packaged SOT & SOD devices
- Ideal for S-parameter, Noise Figure and Power measurements
- De-embedding with TRL Calibration Standards

### TRLCalibration forMidsections

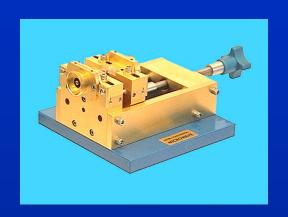


Calibration Kit

#### TRL Calibration Kit

- Matched to Inserts using 25 mil alumina and 330 mil long substrates
- DC 26.5 GHz
- All Calibration Coefficients included
- Includes complete set of Replacement Standards
- Standards build as matched sets
- All Standards mounted on Midsection Adapters

# PackagedTransistor TestSolution



Mainframe



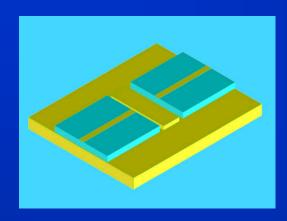
Calibration Kit



Midsection Adapter

Includes Adjustable Mainframe, TRL Calibration Standards and Midsection Adapter

## FETMeasurements atChip Level



**FET Carrier Assembly** 

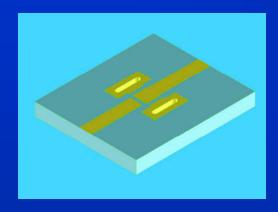


**FET Midsection** 

#### • FET Carrier Assemblies

- Ideal for S-parameter measurements
- De-embedding with TRL Calibration
   Standards
- Measurement Environment Equal to Application Environment
- 10 and 15 mil substrates for DC 40 GHz
   25 mil substrates for DC 25 GHz
- Customer to specify dimensions
- Use ICM Product Note B6137208 and B0137209 FET Carrier Assembly Data Input Form

### BipolarChip Measurements



Bipolar Chip Substrate

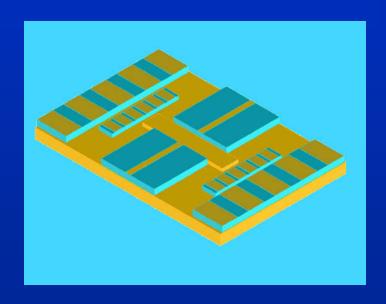


**Bipolar Midsection** 

### Bipolar Substrates

- Ideal for S-parameter measurements
- De-embedding with TRL Calibration
   Standards
- Measurement Environment equal to Application environment
- 10 and 15 mil substrates for DC 40
   GHz
  - 25 mil substrates for DC 26.5 GHz
- Use ICM Product Note B6137210

## MMICCarrier Assemblies

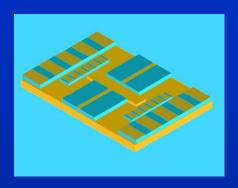


**MMIC Carrier Assembly** 

#### • MMIC Carrier Assemblies

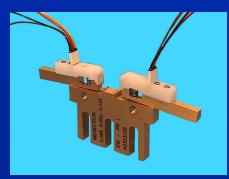
- Ideal for S-parameter measurements
- De-embedding with TRL Calibration
   Standards
- Measurement Environment Equal to Application Environment
- 10 and 15 mil substrates for DC 40
   GHz
   25 mil substrates for DC 25 GHz
- Customer to specify dimensions
- Use ICM Product Note B6137206 and B0137207 MMIC Carrier Assembly Data Input Form

## MMICChip Measurements





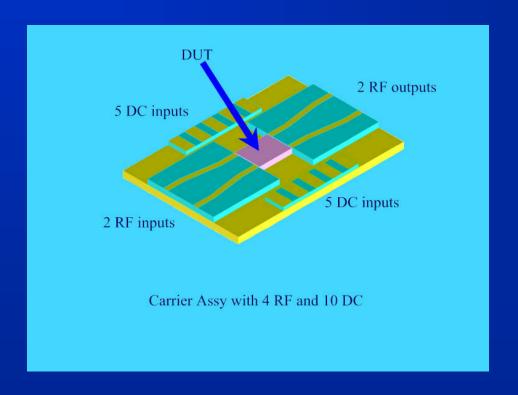




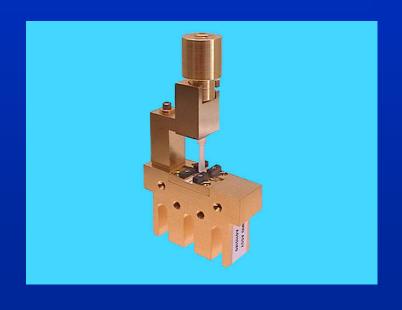
### • MMIC Measurements Setup

- MMIC Carrier Assembly made to fit DUT
- 10 and 15 mil substrates for DC 40
   GHz; 25 mil substrates for DC 26.5 GHz
- MMIC Midsection to fit Carrier Assembly Width
- Uses 2 ea DC Probe Assemblies
- Uses 2 ea DC Cable Assemblies
- DC Probe Assemblies can be moved to other size midsections
- Use ICM product Note B6137206 and MMIC carrier assy. Data Input Form B0137207

# CustomMMIC CarrierAssembly Example

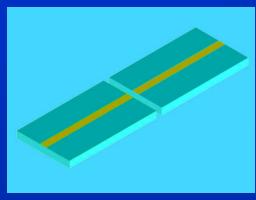


# Other Mainframe Applications

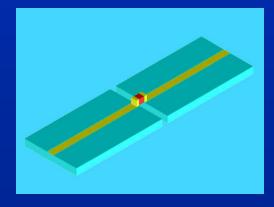


- Capacitor and Inductor Measurements
  - For Surface Mount Devices (SMD)
  - All popular sizes can be tested
  - 3 Measurement Configurations
    - Series Thru
    - Shunt Thru
    - Shunt to Ground
  - All Mainframe can be used
  - TRL Calibration Standards available
  - All Tests non-destructive (no soldering)

### Series-ThruCapacitors andInductor Measurements



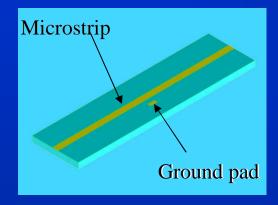
Series-Thru Substrate



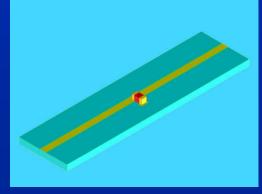
Series-Thru Substrates with DUT

- Measured in <u>Series</u> with a 50 Ohm microstrip Line
  - Features:
    - Calibration establishes reference planes at end of substrate where the DUT makes contact
    - Substrates available with different microstrip width for smaller and larger components
    - Non-destructive clampdown of DUT
    - DURA contacts for long contact life
    - See our website for available sizes

### Shunt-ThruCapacitors andInductor Measurements



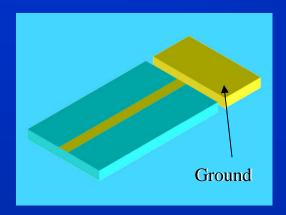
Thru line with ground pad



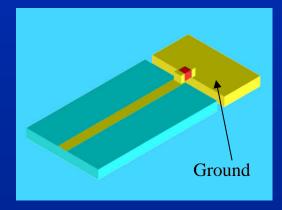
Shunt-Thru Substrate with DUT

- Measured in <u>Shunt</u> with a 50 Ohm microstrip Line
  - Features:
    - Calibration establishes reference planes at + and 50 mils from the center of the substrate
    - DUT is placed between the microstrip line and ground
    - Substrates available with different gaps between microstrip and ground pad for smaller and larger components
    - Non-destructive clampdown of DUT
    - DURA contacts for long contact life
    - See our website for available sizes.

### Shunt-to-Ground Capacitors and Inductor Measurements



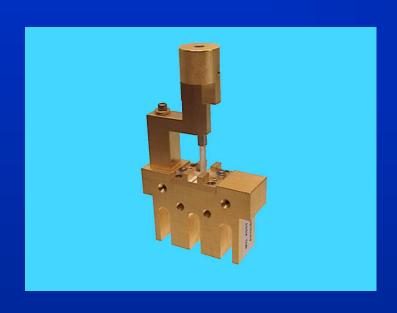
Microstrip with ground pad



Microstrip with DUT to ground

- Measured with a 50 Ohm microstrip
   <u>Line to ground</u>
  - Features:
    - Calibration establishes reference planes at the end of the substrate
    - DUT is placed between the microstrip line and ground
    - Substrates available with different gaps between microstrip and ground pad for smaller and larger components
    - Non-destructive clampdown of DUT
    - DURA contacts for long contact life
    - See our website for available sizes

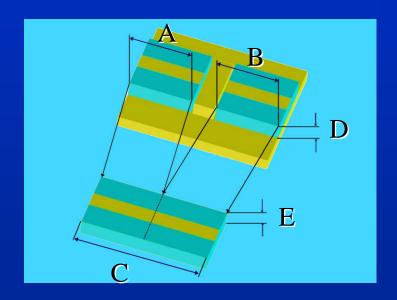
# Non-destructiveBeam -LeadTesting



### • Beam Lead Diode Testing

- Non-destructive RF Measurement
- DC 40 GHz
- Low insertion loss (1 dB typ.)
- High Return loss (20 dB typ.)
- Thru Standard for Calibration included
- Ideal for Pin Diodes, SRD's, etc.
- Midsection Style for mainframes or stand alone
- TRL Calibration Standards for deembedding (S-parameters)

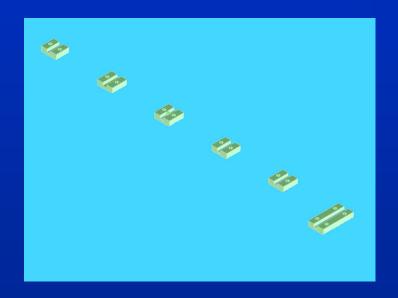
# CalibrationStandards



### • THRU Standard Length

- Length of THRU Standard is related to the carrier assembly
- Length A and Length B = THRUStandard Length C
- Substrate Materials have to be the same
- Thickness of substrate has to be the same (E = D)
- Reference planes at center of THRU
   Standard
- Reference planes on Carrier Assembly at inside edge of substrates

## TRLStandards are "MatchedSets"

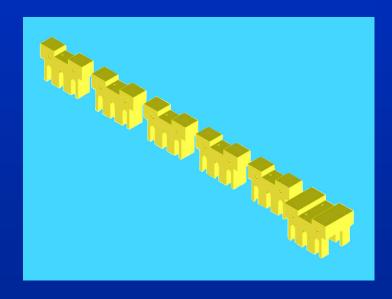


Matched set of Calibration Kit Inserts

#### Matched sets

- TRL Standards are manufactured as matched sets
- Requires to use same mask
- Requires to be manufactured from same substrate
- Tested as Matched Sets
- To achieve the best calibration
   Accuracy the standards should only
   be used as matched sets
- Replacement Standards are available as Matched Sets only

# <u>CalibrationAdapters</u>

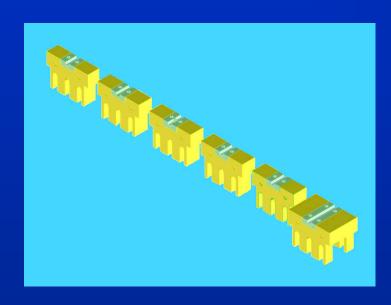


Calibration Adapters

### Calibration Adapters

- Calibration Kits for Mainframes have the standards mounted on Calibration Adapters
- The Calibration Adapters match the width of the Calibration Inserts
- The Calibration Adapter align the Calibration Standards automatically when inserted into the Mainframe

## TRLCalibration Standards



Calibration Adapters with Calibration Inserts

### Adapters and Inserts

- The Calibration Inserts are mounted onto the Calibration Adapters
- The Insert have to be flush with the Adapter when mounted
- Each Calibration Kit is completely assembled when shipped
- A set of Replacement Standards is included with every Mainframe Calibration Kit

### ICMTRL CalibrationStandards



**Calibration Kits** 

#### • TRL Calibration Standards

- Microstrip in-fixture standards
- DC 40 GHz
- For Adjustable Mainframe Fixtures
- 10, 15, 20, 25, and 50 mil alumina substrate thickness available
- Replacement Standards Kits
- Many soft board material Calibration Kits available
- All Calibration coefficients supplied
- Custom Calibration Kits on request